# TPS79301-EP, TPS79318-EP, TPS79325-EP, TPS79328-EP TPS793285-EP, TPS79330-EP, TPS79333-EP, TPS793475-EP

SGLS163B-APRIL 2003-REVISED NOVEMBER 2006

# ULTRALOW-NOISE, HIGH-PSRR, FAST RF 200-mA LOW-DROPOUT LINEAR REGULATORS

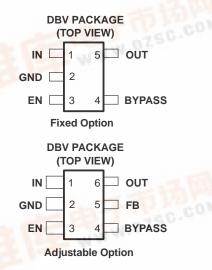
#### **FEATURES**

- Controlled Baseline
  - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- 200-mA Low-Dropout Regulator With EN
- Available in 1.8 V, 2.5 V, 2.8 V, 2.85 V, 3 V,
   3.3 V, 4.75 V, and Adjustable
- High PSRR (70 dB at 10 kHz)
- Ultralow Noise (32 μV)
- Fast Start-Up Time (50 μs)
- Stable With a 2.2-μF Ceramic Capacitor
- Excellent Load/Line Transient
- Very Low Dropout Voltage (112 mV at Full Load, TPS79330)
- 5-Pin SOT23 (DBV) Package

## **APPLICATIONS**

- VCOs
- RF
- Bluetooth™, Wireless LAN

(1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over specified temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.



# DESCRIPTION

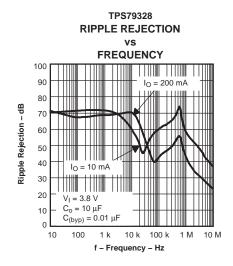
The TPS793xx family of low-dropout (LDO) low-power linear voltage regulators features high power-supply rejection ratio (PSRR), ultralow noise, fast start-up, and excellent line and load transient responses in a small-outline SOT23 package. Each device in the family is stable, with a small 2.2-µF ceramic capacitor on the output. The TPS793xx family uses an advanced, proprietary, BiCMOS fabrication process to yield extremely low dropout voltages (e.g., 112 mV at 200 mA, TPS79330). Each device achieves fast start-up times (approximately 50 μs with a 0.001-μF bypass capacitor), while consuming very low quiescent current (170 µA typical). Moreover, when the device is placed in standby mode, the supply current is reduced to less than 1 µA. The TPS79328 exhibits approximately 32  $\mu V_{RMS}$  of output voltage noise with a 0.1- $\mu F$ capacitor. Applications with components that are noise sensitive, such as portable RF electronics, benefit from the high PSRR and low-noise features, as well as the fast response time.

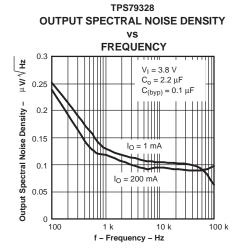
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#### **AVAILABLE OPTIONS**

TJ	VOLTAGE	PACKAGE	PART NUMBER	SYMBOL
	1.2 to 5.5 V		TPS79301DBVREP <sup>(1)</sup>	PGVE
	1.8 V		TPS79318DBVREP <sup>(1)</sup>	PHHE
	2.5 V		TPS79325DBVREP <sup>(1)</sup>	PGWE
400C to 4050C	2.8 V	SOT23 (DBV)	TPS79328DBVREP <sup>(1)(2)</sup>	PGXE
–40°C to 125°C	2.85 V		TPS793285DBVREP <sup>(1)(2)</sup>	PHIE
	3 V	(551)	TPS79330DBVREP <sup>(1)(2)</sup>	PGYE
	3.3 V		TPS793333DBVREP <sup>(1)</sup>	PHUE
	4.75 V		TPS793475DBVREP <sup>(1)</sup>	PHJE
−55°C to 125°C	1.2 to 5.5 V		TPS79301MDBVREP <sup>(1)</sup>	PMBM

<sup>(1)</sup> The DBVR indicates tape and reel of 3000 parts.

<sup>(2)</sup> Product preview

# TPS79301-EP, TPS79318-EP, TPS79325-EP, TPS79328-EP TPS793285-EP, TPS79330-EP, TPS79333-EP, TPS793475-EP

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# ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
	Input voltage range (2)		-0.3	6	V
	Voltage range at EN	-0.3	V <sub>I</sub> + 0.3	V	
	Voltage on OUT	-0.3	6	V	
	Peak output current	Internally lim		limited	
	ESD rating	Human-Body Model (HBM)		2	kV
	ESD fatting	Changed-Device Model (CDM)		500	V
	Continuous total power dissipation	,	See Dis Ratin	sipation g Table	
$T_J$	Operating virtual junction temperature range	-55	125	°C	
T <sub>stg</sub>	Storage temperature range		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# **Dissipation Ratings**

BOARD	PACKAGE	R <sub>θJC</sub>	$R_{ hetaJA}$	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> ≤ 25°C POWER RATING	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING
Low K <sup>(1)</sup>	DBV	63.75°C/W	256°C/W	3.906 mW/°C	391 mW	215 mW	156 mW
High K <sup>(2)</sup>	DBV	63.75°C/W	178.3°C/W	5.609 mW/°C	561 mW	308 mW	224 mW

<sup>(1)</sup> The JEDEC low K (1s) board design used to derive this data was a 3-in x 3-in, two layer board with 2-oz copper traces on top of the board.

<sup>(2)</sup> All voltage values are with respect to network ground terminal

<sup>(2)</sup> The JEDEC high K (2s2p) board design used to derive this data was a 3-in × 3-in, multilayer board with 1-oz internal power and ground planes and 2-oz copper traces on top and bottom of the board.

# TPS79301-EP, TPS79318-EP, TPS79325-EP, TPS79328-EP TPS793285-EP, TPS79330-EP, TPS79333-EP, TPS793475-EP





# **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range, EN =  $V_I$ ,  $T_J$  = -55 to 125°C and  $T_J$  = -40 to 125°C,  $V_I$  =  $V_{O(typ)}$  + 1 V,  $I_O$  = 1 mA,  $C_o$  = 10  $\mu$ F,  $C_{(byp)}$  = 0.01  $\mu$ F (unless otherwise noted)

PARAMETER		TEST CON	TEST CONDITIONS				UNIT	
V <sub>I</sub> Input voltage <sup>(1)</sup>				2.7		5.5	V	
I <sub>O</sub> Continuous output	current <sup>(2)</sup>			0		200	mA	
T <sub>J</sub> Operating junction	temperature			-55		125	°C	
	TPS79301	$0 \mu A < I_O < 200 mA$ , 1.22 V ≤ V <sub>O</sub> ≤ 5.2 V <sup>(3)</sup>	$T_J = -40 \text{ to } 125^{\circ}\text{C},$	0.98 Vo		1.02 Vo		
	17-37-9301	0 $\mu$ A < I <sub>O</sub> < 200 mA, 1.22 V $\leq$ V <sub>O</sub> $\leq$ 5.2 V $^{(3)}$	$T_J = -55 \text{ to } 125^{\circ}\text{C},$	0.97 Vo		1.025 Vo		
	TPS79318	$T_J = 25^{\circ}C$			1.8			
	173/9310	$0 \mu A < I_O < 200 mA$ ,	$2.8 \text{ V} < \text{V}_{\text{I}} < 5.5 \text{ V}$	1.764		1.836		
	TPS79325	$T_J = 25^{\circ}C$			2.5			
	173/9323	$0 \mu A < I_O < 200 mA$ ,	$3.5 \text{ V} < \text{V}_{\text{I}} < 5.5 \text{ V}$	2.45		2.55		
	TPS79328	T <sub>J</sub> = 25°C			2.8			
Output voltage	175/9326	$0 \mu A < I_O < 200 mA$ ,	3.8 V < V <sub>I</sub> < 5.5 V	2.744		2.856	V	
	TD0702005	T <sub>J</sub> = 25°C			2.85			
	TPS793285	$0  \mu A < I_O < 200  mA$	3.85 V < V <sub>I</sub> < 5.5 V	2.793		2.907		
	TD07000	T <sub>J</sub> = 25°C			3			
	TPS79330	0 μA < I <sub>O</sub> < 200 mA,	4 V < V <sub>I</sub> < 5.5 V	2.94		3.06		
		T <sub>J</sub> = 25°C			3.3			
	TPS79333	0 μA < I <sub>O</sub> < 200 mA,	4.3 V < V <sub>I</sub> < 5.5 V	3.234		3.366		
	TD0700475	T <sub>J</sub> = 25°C			4.75			
	TPS793475	0 μA < I <sub>O</sub> < 200 mA,	5.25 V < V <sub>I</sub> < 5.5 V	4.655		4.845		
0 1		0 μA < I <sub>O</sub> < 200 mA,		170				
Quiescent current (GND o	current)	0 μA < I <sub>O</sub> < 200 mA			220	μΑ		
Load regulation		$0 \mu A < I_O < 200 \text{ mA}, \qquad T_J = 25^{\circ} \text{C}$			5		mV	
0		$V_{O} + 1 V < V_{I} \le 5.5 V$	T <sub>J</sub> = 25°C		0.05		0/ 0/	
Output voltage line regula	ation $(\Delta V_0/V_0)^{(4)}$	$V_0 + 1 V < V_1 \le 5.5 V$				0.12	%/V	
			$C_{(byp)} = 0.001  \mu F$		55			
0	070000)	BW = 200 Hz to 100 kHz,	$C_{(byp)} = 0.0047 \mu\text{F}$		36		.,	
Output noise voltage (TP	\$79328)	$I_{O} = 200 \text{ mA}, T_{J} = 25^{\circ}\text{C}$	$C_{(byp)} = 0.01  \mu F$		33		$\mu V_{RMS}$	
			$C_{(byp)} = 0.1  \mu F$		32			
			$C_{(byp)} = 0.001 \mu\text{F}$		50			
Time, start-up (TPS79328)		$R_L = 14 \Omega,$ $C_0 = 1 \mu F, T_J = 25^{\circ}C$	$C_{(byp)} = 0.0047 \mu\text{F}$		70		μs	
		$C_0 = 1  \mu \text{F},  T_J = 25  \text{C}$	$C_{(byp)} = 0.01  \mu F$		100			
Output current limit		V <sub>O</sub> = 0 V <sup>(3)</sup>	285		600	mA		
Standby current		$EN = 0 \text{ V},$ $2.7 \text{ V} < \text{V}_1 < 5.5 \text{ V}$			0.07	1	μΑ	
High-level enable input vo	oltage	2.7 V < V <sub>I</sub> < 5.5 V	•				V	
Low-level enable input vo	oltage	2.7 V < V <sub>I</sub> < 5.5 V			0.7	V		
Input current (EN)	-	EN = 0				1	μΑ	

<sup>(1)</sup> To calculate the minimum input voltage for your maximum output current, use the following formula:  $V_I(min) = V_O(max) + V_{DO} (max load)$ 

(4) If 
$$V_0 \le 2.5 \text{ V}$$
, then  $V_{\text{Imin}} = 2.7 \text{ V}$ ,  $V_{\text{Imax}} = 5.5 \text{ V}$ :

output current is 200 mA. If 
$$V_O \le 2.5$$
 V, then  $V_{Imin} = 2.7$  V,  $V_{Imax} = 5.5$  V: Line Reg. (mV) =  $(\%/V) \times \frac{V_O(V_{Imax} - 2.7 \text{ V})}{100} \times 1000$  If  $V_O \ge 2.5$  V, then  $V_{Imin} = V_O + 1$  V,  $V_{Imax} = 5.5$  V.

Continuous output current and operating junction temperature are limited by internal protection circuitry, but it is not recommended that

the device operate under conditions beyond those specified in this table for extended periods of time. The minimum IN operating voltage is 2.7 V or  $V_{O(typ)}$  + 1 V, whichever is greater. The maximum IN voltage is 5.5 V. The maximum

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# **ELECTRICAL CHARACTERISTICS (continued)**

over recommended operating free-air temperature range, EN =  $V_I$ ,  $T_J$  = -55 to 125°C and  $T_J$  = -40 to 125°C,  $V_I$  =  $V_{O(typ)}$  + 1 V,  $I_O$  = 1 mA,  $C_o$  = 10  $\mu$ F,  $C_{(byp)}$  = 0.01  $\mu$ F (unless otherwise noted)

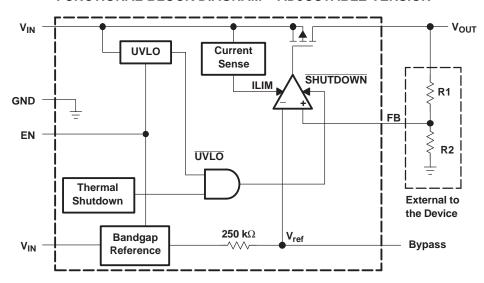
PARAN	METER	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT			
Input current (FB) (TPS	79301)	FB = 1.8 V				1	μΑ			
		f = 100 Hz, T <sub>J</sub> = 25°C,	I <sub>O</sub> = 10 mA		70					
Power-supply ripple rejection	TPS79328	$f = 100 \text{ Hz}, T_J = 25^{\circ}\text{C},$	$I_{O} = 200 \text{ mA}$		68		dB			
	175/9326	$f = 10 \text{ Hz}, T_J = 25^{\circ}\text{C},$	I <sub>O</sub> = 200 mA		70		uБ			
		f = 100 Hz, T <sub>J</sub> = 25°C,	I <sub>O</sub> = 200 mA		43					
	TPS79328	I <sub>O</sub> = 200 mA,	T <sub>J</sub> = 25°C		120					
	17 37 9320	I <sub>O</sub> = 200 mA				200				
	TPS793285	I <sub>O</sub> = 200 mA,	T <sub>J</sub> = 25°C		120					
		I <sub>O</sub> = 200 mA				200				
Dranaut valtage (5)		I <sub>O</sub> = 200 mA,	T <sub>J</sub> = 25°C		112		m\/			
Dropout voltage <sup>(5)</sup>	TPS79330	I <sub>O</sub> = 200 mA				200	mV			
	TPS79333	I <sub>O</sub> = 200 mA,	T <sub>J</sub> = 25°C		102					
	17579333	I <sub>O</sub> = 200 mA				180				
	TD0702475	I <sub>O</sub> = 200 mA,	T <sub>J</sub> = 25°C		77					
	TPS793475	I <sub>O</sub> = 200 mA				125				
UVLO threshold		V <sub>CC</sub> rising		2.25		2.65	V			
UVLO hysteresis		T <sub>J</sub> = 25°C	V <sub>CC</sub> rising		100		mV			

<sup>(5)</sup> IN voltage equals  $V_{O(typ)}$ - 100 mV; The TPS79325 dropout voltage is limited by the input voltage range limitations.

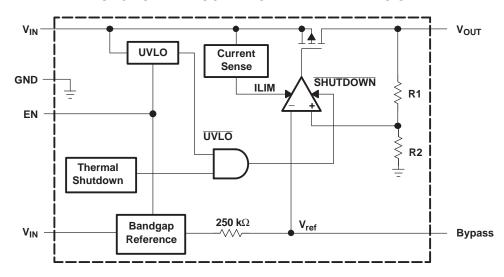


## **DEVICE INFORMATION**

## **FUNCTIONAL BLOCK DIAGRAM - ADJUSTABLE VERSION**



#### **FUNCTIONAL BLOCK DIAGRAM - FIXED VERSION**

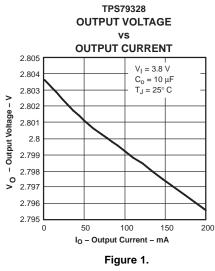


#### **TERMINAL FUNCTIONS**

TERMINAL		ERMINAL		TERMINAL		ERMINAL		TERMINAL		DESCRIPTION
NAME	ADJ	FIXED	I/O	DESCRIPTION						
BYPASS	4	4		An external bypass capacitor, connected to this terminal, in conjunction with an internal resistor, creates a low-pass filter to further reduce regulator noise.						
EN	3	3	1	Enable input that enables or shuts down the device. When EN goes to a logic high, the device is enabled. When the device goes to a logic low, the device is in shutdown mode.						
FB	5	N/A	I	Feedback input voltage for the adjustable device						
GND	2	2		Regulator ground						
IN	1	1	I	Input to the device						
OUT	6	5	0	Regulated output of the device						



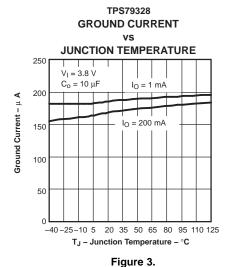
#### TYPICAL CHARACTERISTICS



TPS79328 **OUTPUT VOLTAGE** VS JUNCTION TEMPERATURE 2.805 2.8  $I_O = 1 \text{ mA}$  Output Voltage 2.795 2.79 I<sub>O</sub> = 200 mA 2.785 2.78  $V_1 = 3.8 \text{ V}$  $C_0 = 10 \mu F$ -40 -25 -10 5 20 35 50 65 80 95 110 125 T<sub>J</sub> - Junction Temperature - °C

Figure 2.

**TPS79328** 

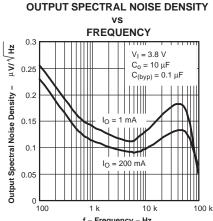


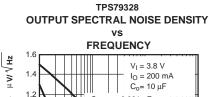
TPS79328 **OUTPUT SPECTRAL NOISE DENSITY** vs **FREQUENCY**  $V_1 = 3.8 \text{ V}$  $C_0 = 2.2 \ \mu F$ 

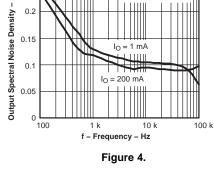
 $C_{(byp)} = 0.1 \mu F$ 

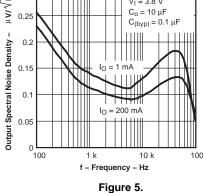
μV// Hz

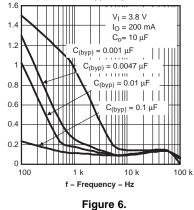
0.25





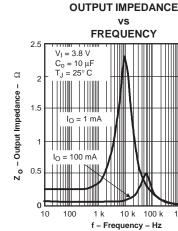




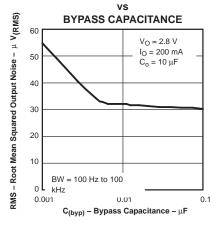


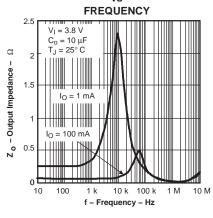
**Output Spectral Noise Density** 

**ROOT MEAN SQUARED OUTPUT NOISE** 



**TPS79328** 





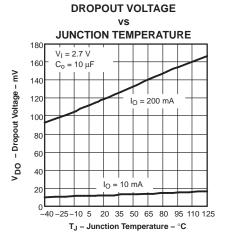


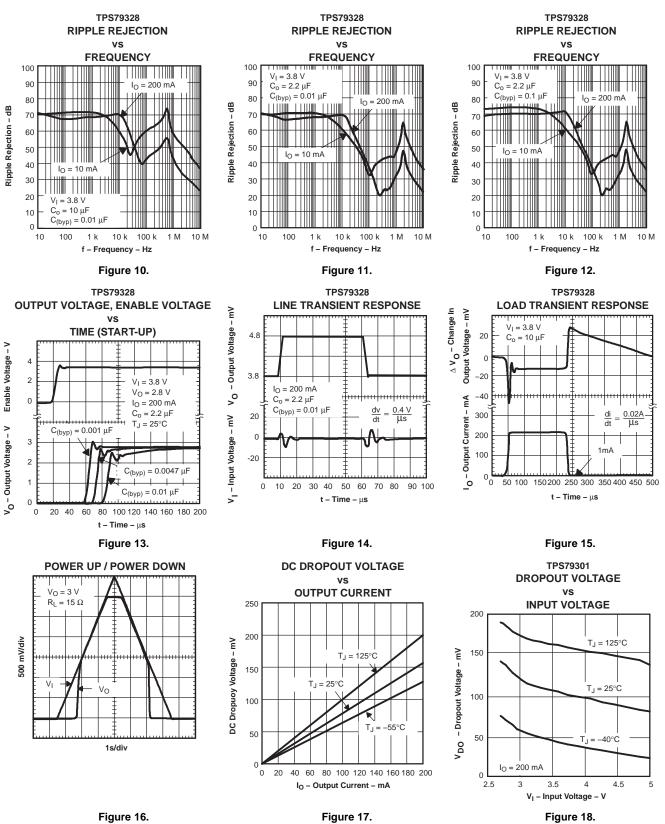
Figure 7.

Figure 8.

Figure 9.

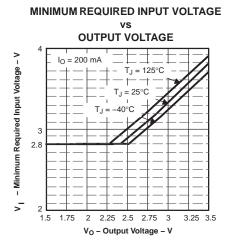


# TYPICAL CHARACTERISTICS (continued)

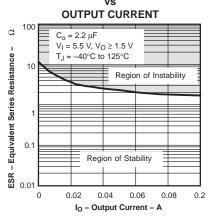


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# TYPICAL CHARACTERISTICS (continued)



TYPICAL REGIONS OF STABILITY EQUIVALENT SERIES RESISTANCE (ESR)



TYPICAL REGIONS OF STABILITY EQUIVALENT SERIES RESISTANCE (ESR)

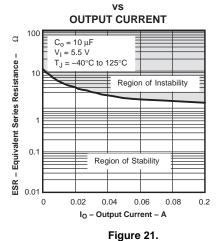


Figure 19. Figure 20.



#### **APPLICATION INFORMATION**

The TPS793xx family of low-dropout (LDO) regulators has been optimized for use in noise-sensitive battery-operated equipment. The device features extremely low dropout voltages, high PSRR, ultralow output noise, low quiescent current (170  $\mu$ A typically), and enable-input to reduce supply currents to less than 1  $\mu$ A when the regulator is turned off.

A typical application circuit is shown in Figure 22.

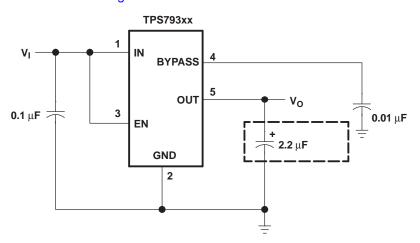


Figure 22. Typical Application Circuit

#### **External Capacitor Requirements**

A  $0.1-\mu F$  or larger ceramic input bypass capacitor, connected between IN and GND and located close to the TPS793xx, is required for stability and improves transient response, noise rejection, and ripple rejection. A higher-value electrolytic input capacitor may be necessary if large, fast-rise-time load transients are anticipated and the device is located several inches from the power source.

Like all LDOs, the TPS793xx requires an output capacitor connected between OUT and GND to stabilize the internal control loop. The minimum recommended capacitance is 2.2-μF. Any 2.2-μF or larger ceramic capacitor is suitable, provided the capacitance does not vary significantly over temperature.

The internal voltage reference is a key source of noise in an LDO regulator. The TPS793xx has a BYPASS pin that is connected to the voltage reference through a 250-k $\Omega$  internal resistor. The 250-k $\Omega$  internal resistor, in conjunction with an external bypass capacitor connected to the BYPASS pin, creates a low pass filter to reduce the voltage reference noise and, therefore, the noise at the regulator output. In order for the regulator to operate properly, the current flow out of the BYPASS pin must be at a minimum, because any leakage current creates an IR drop across the internal resistor, thus, creating an output error. Therefore, the bypass capacitor must have minimal leakage current.

For example, the TPS79328 exhibits only 32  $\mu V_{RMS}$  of output voltage noise using a 0.1- $\mu F$  ceramic bypass capacitor and a 2.2- $\mu F$  ceramic output capacitor. Note that the output starts up slower as the bypass capacitance increases due to the RC time constant at the BYPASS pin that is created by the internal 250- $k\Omega$  resistor and external capacitor.

# **Board Layout Recommendation to Improve PSRR and Noise Performance**

To improve ac measurements like PSRR, output noise, and transient response, it is recommended that the board be designed with separate ground planes for  $V_{\text{IN}}$  and  $V_{\text{OUT}}$ , with each ground plane connected only at the GND pin of the device. In addition, the ground connection for the bypass capacitor should connect directly to the GND pin of the device.

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# **APPLICATION INFORMATION (continued)**

## **Power Dissipation and Junction Temperature**

Specified regulator operation is ensured to a junction temperature of 125°C; the maximum junction temperature should be restricted to 125°C under normal operating conditions. This restriction limits the power dissipation the regulator can handle in any given application. To ensure the junction temperature is within acceptable limits, calculate the maximum allowable dissipation,  $P_{D(max)}$ , and the actual dissipation,  $P_D$ , which must be less than or equal to  $P_{D(max)}$ .

The maximum power dissipation limit is determined using the following equation:

$$P_{D(max)} = \frac{T_{J}max - T_{A}}{R_{\theta JA}}$$
(1)

Where:

T<sub>J</sub>max = Maximum allowable junction temperature

 $R\theta_{JA}$  = Thermal resistance, junction to ambient, for the package, see the dissipation rating table

 $T_A$  = Ambient temperature

The regulator dissipation is calculated using:

$$P_{D} = (V_{I} - V_{O}) \times I_{O}$$
 (2)

Power dissipation resulting from quiescent current is negligible. Excessive power dissipation triggers the thermal protection circuit.

# Programming the TPS79301 Adjustable LDO Regulator

The output voltage of the TPS79301 adjustable regulator is programmed using an external resistor divider as shown in Figure 23. The output voltage is calculated using:

$$V_{O} = V_{ref} \times \left(1 + \frac{R1}{R2}\right) \tag{3}$$

Where:

 $V_{ref} = 1.2246 \text{ V}$  typical (the internal reference voltage)



# **APPLICATION INFORMATION (continued)**

## Programming the TPS79301 Adjustable LDO Regulator (continued)

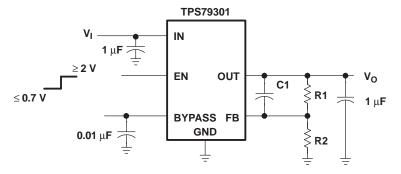
Resistors R1 and R2 should be chosen for approximately 50- $\mu$ A divider current. Lower-value resistors can be used for improved noise performance, but the solution consumes more power. Higher resistor values should be avoided as leakage current into/out of FB across R1/R2 creates an offset voltage that artificially increases/decreases the feedback voltage and, thus, erroneously decreases/increases  $V_O$ . The recommended design procedure is to choose R2 = 30.1 k $\Omega$  to set the divider current at 50  $\mu$ A, C1 = 15 pF for stability, and then calculate R1 using:

$$R1 = \left(\frac{V_{O}}{V_{ref}} - 1\right) \times R2 \tag{4}$$

In order to improve the stability of the adjustable version, it is suggested that a small compensation capacitor be placed between OUT and FB. For voltages <1.8 V, the value of this capacitor should be 100 pF. For voltages >1.8 V, the approximate value of this capacitor can be calculated as:

C1 = 
$$\frac{(3 \times 10^{-7}) \times (R1 + R2)}{(R1 \times R2)}$$
 (5)

The suggested value of this capacitor for several resistor ratios is shown in the table below. If this capacitor is not used (such as in a unity-gain configuration) or if an output voltage <1.8 V is chosen, then the minimum recommended output capacitor is  $4.7 \, \mu F$  instead of  $2.2 \, \mu F$ .



# OUTPUT VOLTAGE PROGRAMMING GUIDE

OUTPUT VOLTAGE	R1	R2	C1	
2.5 V	31.6 kΩ	30.1 kΩ	22 pF	
3.3 V	51 kΩ	30.1 kΩ	15 pF	
3.6 V	59 kΩ	30.1 kΩ	15 pF	

Figure 23. TPS79301 Adjustable LDO Regulator Programming

## **Regulator Protection**

The TPS793xx features internal current limiting and thermal protection. During normal operation, the TPS793xx limits output current to approximately 400 mA. When current limiting engages, the output voltage scales back linearly until the overcurrent condition ends. While current limiting is designed to prevent gross device failure, care should be taken not to exceed the power dissipation ratings of the package or the absolute maximum voltage ratings of the device. If the temperature of the device exceeds approximately 165°C, thermal-protection circuitry shuts it down. Once the device has cooled down to below approximately 140°C, regulator operation resumes.

6-Feb-2009

#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TPS79301DBVREP	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS79301MDBVREP	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS79318DBVREP	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS79325DBVREP	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS79333DBVREP	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS793475DBVREP	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/03634-01YE	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/03634-02XE	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/03634-03XE	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/03634-07XE	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/03634-08XE	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/03634-09XE	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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# PACKAGE OPTION ADDENDUM



6-Feb-2009

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## OTHER QUALIFIED VERSIONS OF TPS79301-EP, TPS79318-EP, TPS79325-EP, TPS79333-EP, TPS793475-EP:

- Catalog: TPS79301, TPS79318, TPS79325, TPS79333, TPS793475
   Automotive: TPS79301-Q1, TPS79318-Q1, TPS79325-Q1, TPS79333-Q1, TPS793475-Q1

NOTE: Qualified Version Definitions:

- Catalog Tl's standard catalog product
   Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

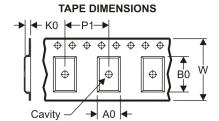


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20-Jul-2010

# TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



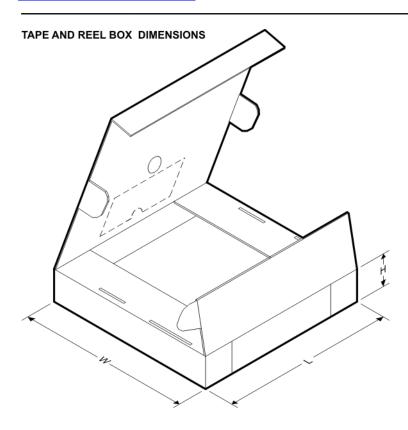
\*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS79301DBVREP	SOT-23	DBV	6	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS79301MDBVREP	SOT-23	DBV	6	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS79318DBVREP	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS79325DBVREP	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS79333DBVREP	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS793475DBVREP	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3





20-Jul-2010

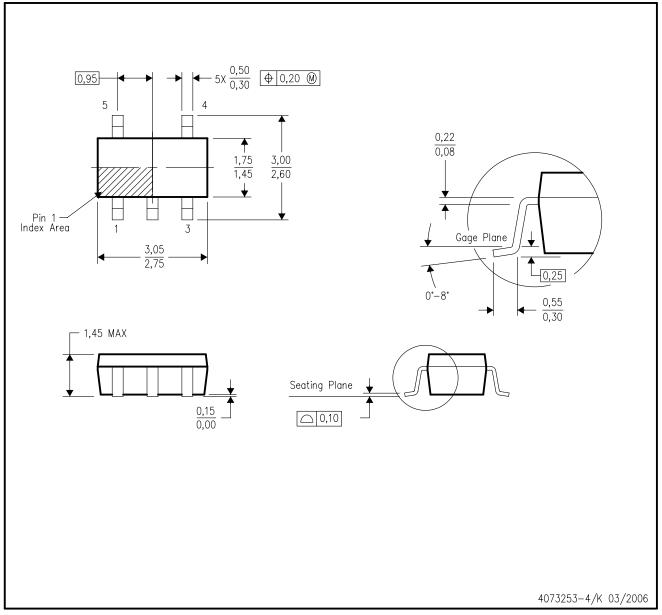


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS79301DBVREP	SOT-23	DBV	6	3000	182.0	182.0	20.0
TPS79301MDBVREP	SOT-23	DBV	6	3000	203.0	203.0	35.0
TPS79318DBVREP	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS79325DBVREP	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS79333DBVREP	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS793475DBVREP	SOT-23	DBV	5	3000	182.0	182.0	20.0

# DBV (R-PDSO-G5)

# PLASTIC SMALL-OUTLINE PACKAGE

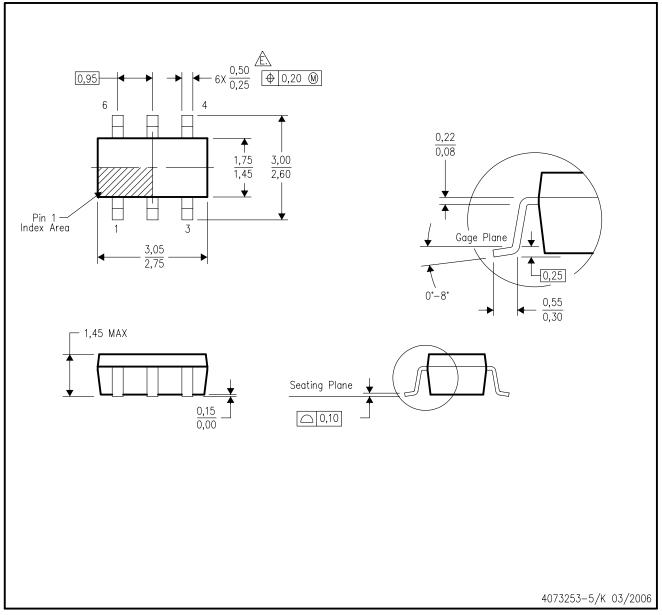


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-178 Variation AA.



# DBV (R-PDSO-G6)

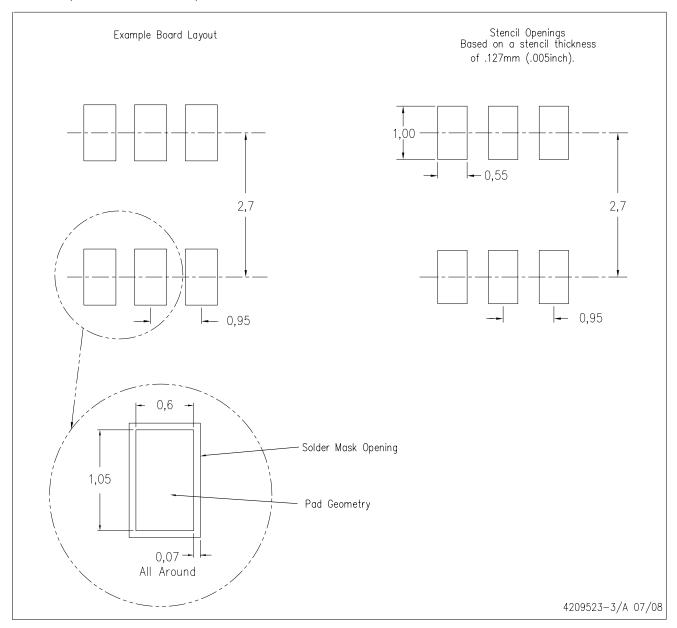
# PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.



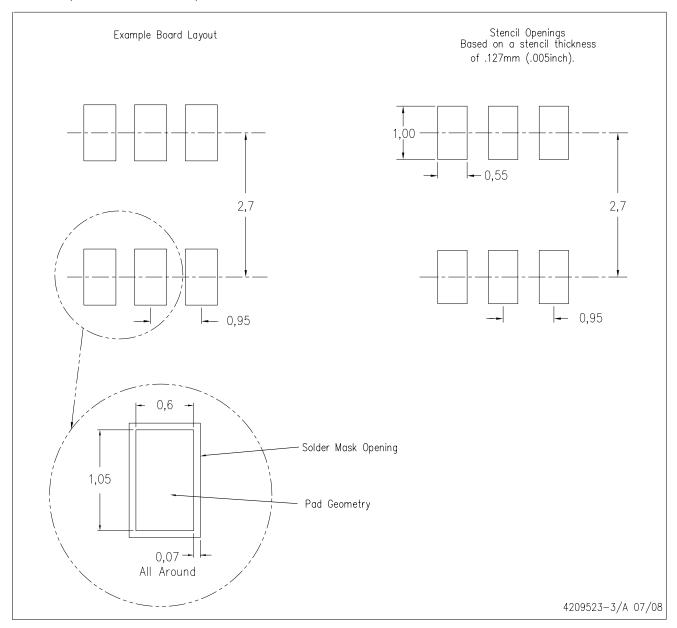
# DBV (R-PDSO-G6)



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



# DBV (R-PDSO-G6)



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